

# 2.4GHz 3216 Chip Antenna: RANT3216F245X02

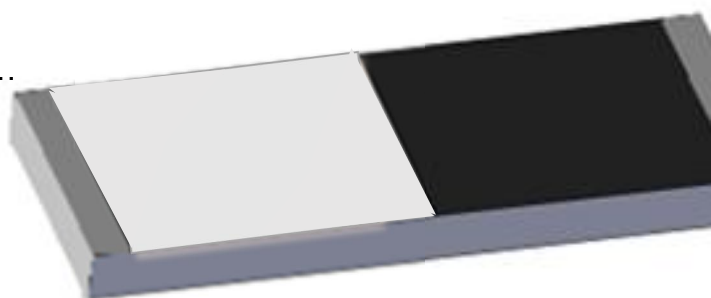


## Application:

WLAN, 802.11b/g, Bluetooth, WLAN, etc...

## Features

SMD, high reliability, ultra Impact, Omni-directional...



## Part number Information

RANT 3216 F 245 X 02  
(A) (B) (C) (D) (E) (F)

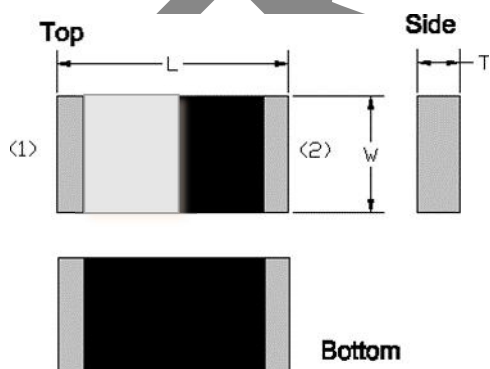
|                  |                       |
|------------------|-----------------------|
| (A) Product Type | Chip Antenna          |
| (B) Size Code    | 3.2x1.6mm(±0.2mm)     |
| (C) Material     | High K material       |
| (D) Frequency    | 2.4 ~ 2.5GHz          |
| (E) Feeding mode | PIFA & Single Feeding |
| (F) Antenna type | Type=01               |

## Electrical Specification

|                               |                    |
|-------------------------------|--------------------|
| Working Frequency Range       | 2400 ~2500 MHz     |
| Bandwidth                     | 120 MHz (Min.)     |
| Peak Gain                     | FEG I AdBiA(Typ.)  |
| Impedance                     | 50 Ohm             |
| Return loss                   | 10 dB ( Min)       |
| Polarization                  | Linear             |
| Azimuth Beamwidth             | Omni-directional   |
| Operation Temperature(°C)     | -40 ~85 °C         |
| Resistance to Soldering Heats | 10sec. ( @ 280°C)  |
| Termination                   | Ni / Au (Leadless) |

The specification is defined on EVB.

## Dimension and Terminal Configuration



| Dimension (mm) |             |
|----------------|-------------|
| L              | 3.20 ± 0.20 |
| W              | 1.60 ± 0.20 |
| T              | 0.45 ± 0.20 |

| No. | Terminal Name |
|-----|---------------|
| 1   | Feeding/GNG   |
| 2   | GND/Feeding   |

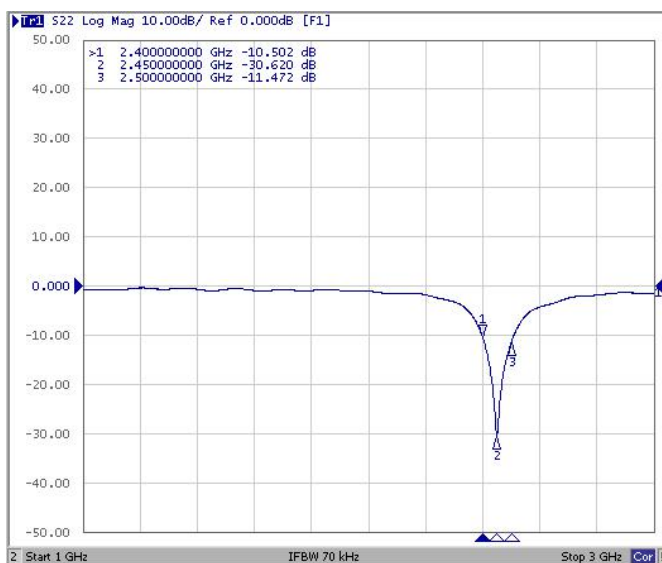
## Evaluation Board Reference

| PCB Dimension | Antenna Layout Reference                   |
|---------------|--|
|               | <p style="text-align: right;">Unit :mm</p> |

## Electrical Characteristics

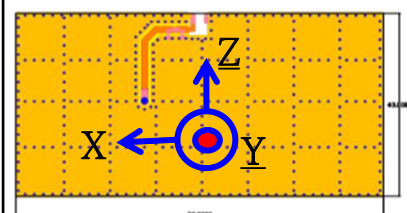
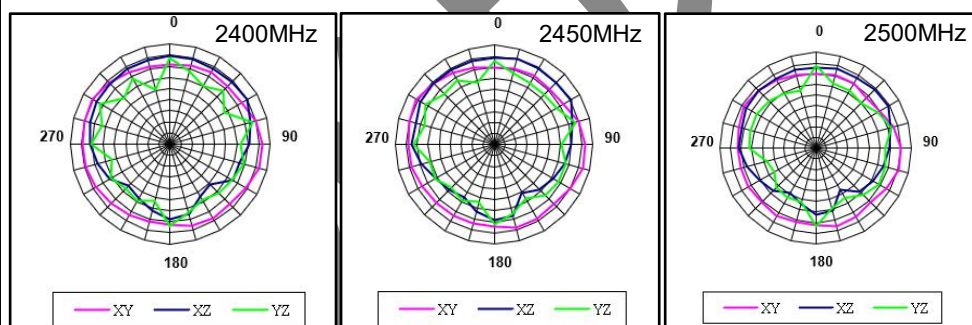
### Return Loss & Radiation

#### Return Loss

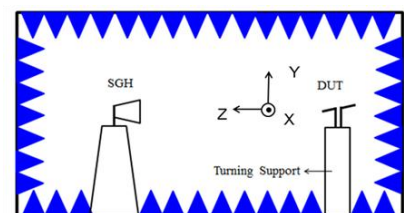


| Frequency(MHz) | S11 (dB) |
|----------------|----------|
| 2400           | -10.50   |
| 2450           | -30.62   |
| 2500           | -11.47   |

#### Radiation



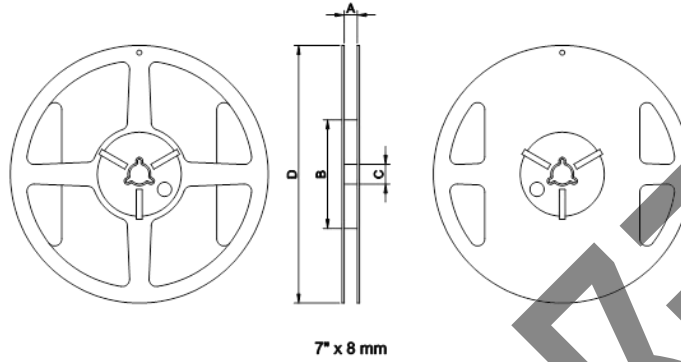
|             | 2400MHz  | 2450MHz  | 2500MHz  |
|-------------|----------|----------|----------|
| Efficiency  | 82.52%   | 85.26%   | 83.01%   |
| Peak Gain   | 1.15 dBi | 1.24 dBi | 1.19 dBi |
| Directivity | 1.89 dBi | 1.97 dBi | 1.91 dBi |



## Taping Specifications

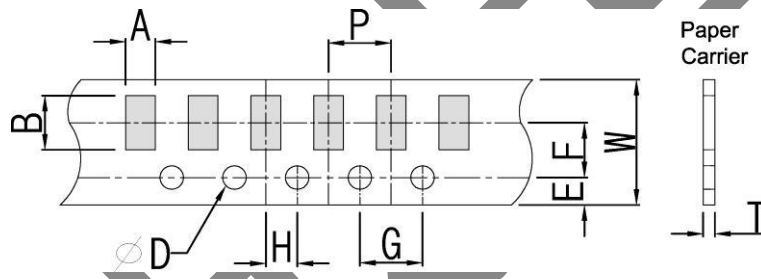
### Reel and Taping Specification

#### Reel Specification



| TYPE | SIZE |         | A       | B    | C        | D     |
|------|------|---------|---------|------|----------|-------|
| 3216 | 7"   | 5K/Reel | 9.0±0.5 | 60±2 | 13.5±0.5 | 178±2 |

#### Tapping Specification



| Packaging  | Type | A         | B         | W        | E         | F        | G        | H        | T         | $\psi D$  | P       |
|------------|------|-----------|-----------|----------|-----------|----------|----------|----------|-----------|-----------|---------|
| Paper Type | 3216 | 1.90±0.20 | 3.50±0.20 | 8.0±0.20 | 1.75±0.10 | 3.5±0.05 | 4.0±0.10 | 2.0±0.05 | 0.75±0.10 | 1.50±0.10 | 4.0±0.1 |

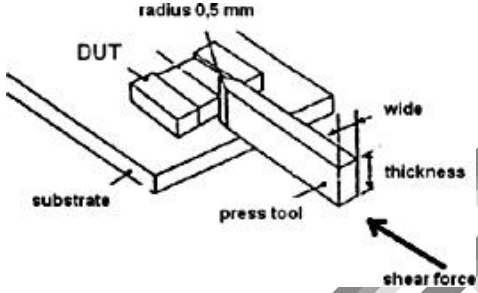
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### Reliability Table

| Test Item                              | Procedure  | Requirements<br>Ceramic Type  | Remark<br>(Reference)     |
|--|--|---|---------------------------|
| <b>Electrical Characterization</b>     |  | Fulfill the electrical specification                                  | User Spec.                |
| <b>Thermal Shock</b>                   | <ol style="list-style-type: none"> <li>Preconditioning:<br/>50 ± 10°C / 1 hr , then keep for 24 ± 1 hrs at room temp.</li> <li>Initial measure: Spec: refer Initialspec.</li> <li>Rapid change of temperature test:<br/>-30°C to +85°C; 100 cycles;<br/>15 minutes at Lower category temperature;<br/>15 minutes at Upper category temperature.</li> </ol> | No Visible Damage.<br>Fulfill the electrical specification.           | MIL-STD-202<br>107        |
| <b>Temperature Cycling</b>             | <ol style="list-style-type: none"> <li>Initial measure: Spec: refer Initialspec.</li> <li>100 Cycles (-30°C to +85°C), Soak Mode=1 (2 Cycle/hours).</li> <li>Measurement at 24 ± 2Hours after test condition.</li> </ol>   | No Visible Damage.<br>Fulfill the electrical specification.           | JESD22<br>JA104           |
| <b>High Temperature Exposure</b>       | <ol style="list-style-type: none"> <li>Initial measure: Spec: refer Initialspec.</li> <li>Unpowered; 500hours @ T=+85°C.</li> <li>Measurement at 24 ± 2 hours aftertest.</li> </ol>  | No Visible Damage.<br>Fulfill the electrical specification.           | MIL-STD-202<br>108        |
| <b>Low Temperature Storage</b>         | <ol style="list-style-type: none"> <li>Initial measure: Spec: refer Initialspec.</li> <li>Unpowered: 500hours @ T=-30°C.</li> <li>Measurement at 24 ± 2 hours aftertest.</li> </ol>  | No Visible Damage.<br>Fulfill the electrical specification.           | MIL-STD-202<br>108        |
| <b>Solderability (SMD Bottom Side)</b> | Dipping method:<br><ol style="list-style-type: none"> <li>Temperature: 235 ± 5°C</li> <li>Dipping time: 3 ± 0.5s</li> </ol>  | The solder should cover over 95% of the critical area of bottom side. | IEC 60384-21/22<br>4.10   |
| <b>Soldering Heat Resistance (RSH)</b> | Preheating temperature: 150 ± 10°C.<br>Preheating time: 1~2 min.<br>Solder temperature: 260 ± 5°C.<br>Dipping time: 5 ± 0.5s   | No Visible Damage.  | IEC 60384-21/22<br>4.10   |
| <b>Vibration</b>                       | 5g's for 20 min., 12 cycles each of 3 orientations<br>Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.   | No Visible Damage.  | MIL-STD-202<br>Method 204 |
| <b>Mechanical Shock</b>                | Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks)<br>Peak value: 1,500g's<br>Duration: 0.5ms<br>Velocity change: 15.4 ft/s<br>Waveform: Half-sine   | No Visible Damage.  | MIL-STD-202<br>Method 213 |
| <b>Humidity Bias</b>                   | <ol style="list-style-type: none"> <li>Humidity: 85% R.H., Temperature: 85 ± 2 °C.</li> <li>Time: 500 ± 24 hours.</li> <li>Measurement at 24 ± 2hrs after test condition.</li> </ol>   | No Visible Damage.<br>Fulfill the electrical specification.           | MIL-STD-202<br>Method 106 |

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|                           |   |  |                         |
|---------------------------|---|--|-------------------------|
| <b>Board Flex (SMD)</b>   | <p>1. Mounting method:<br/>IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm)</p> <p>2. Apply the load in direction of the arrow until bending reaches 2 mm.</p>                                    | <p>No Visible Damage.</p>  | <p>AEC-Q200<br/>005</p> |
| <b>Adhesion</b>           | <p>Force of 1.8Kg for 60 seconds.</p>    | <p>No Visible Damage<br/>Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.</p> | <p>AEC-Q200<br/>006</p> |
| <b>Physical Dimension</b> | <p>Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.</p> | <p>In accordance with specification.</p>   | <p>JESD22<br/>JB100</p> |

### Revision History

| Revision | Date       | Content                         |
|----------|------------|---------------------------------|
| 1        | 2019/03/01 | New Datasheet                   |
| 2        | 2021/02/22 | Add 2D radiation characteristic |